

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Keiichi Hatakeyama</td> <td>04/15/2010</td> </tr> <tr> <td>Yuuki Nakamura</td> <td>04/19/2010</td> </tr> </tbody> </table>		Name	Execution Date	Keiichi Hatakeyama	04/15/2010	Yuuki Nakamura	04/19/2010						
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CORRESPONDENCE DATA													
<p>Fax Number: (703)312-6666 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 703-312-6600 Email: rperez@antonelli.com Correspondent Name: ANTONELLI, TERRY, STOUT & KRAUS, LLP Address Line 1: 1300 NORTH SEVENTEENTH STREET Address Line 2: SUITE 1800 Address Line 4: ARLINGTON, VIRGINIA 22209-3873</p>													
ATTORNEY DOCKET NUMBER:	1303.50689X00												
NAME OF SUBMITTER:	William I. Solomon												
Total Attachments: 1 source=Assignment#page 1.tif													

OP \$40.00 12682254

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PATENT
REEL: 024889 FRAME: 0015

ASSIGNMENT

Whereas, I/we,

NameAddress1) **Keiichi HATAKEYAMA**

c/o HITACHI CHEMICAL COMPANY, LTD.,

48, Wadai,
Tsukuba-shi, Ibaraki 300-4247 Japan

c/o HITACHI CHEMICAL COMPANY, LTD.,

2) **Yuuki NAKAMURA**13-1, Higashi-cho 4-chome,
Hitachi-shi, Ibaraki 317-8555 Japan

hereinafter called assignor(s), have invented certain improvements in

METHOD FOR PRODUCING SEMICONDUCTOR CHIP WITH ADHESIVE FILM, ADHESIVE FILM FOR SEMICONDUCTOR USED IN THE METHOD, AND METHOD FOR PRODUCING SEMICONDUCTOR DEVICE

and executed an application for Letters Patent of the United States of America therefor on even date herewith unless otherwise indicated below:

filed on April 9, 2010Serial No. 12/682254; and

Whereas

HITACHI CHEMICAL COMPANY, LTD.1-1, Nishi-Shinjuku 2-chome,
Shinjuku-ku, Tokyo 163-0449 Japan

(assignee), desires to acquire the entire right, title and interest in the application and invention, and to any United States patents to be obtained therefor;

NOW THEREFORE, be it known that, for good and valuable consideration from assignee, the receipt of which is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

INVENTORSDATE SIGNED
 1): Keiichi Hatakeyama
 Name: Keiichi HATAKEYAMA
2010. 4. 15
 2): Yuuki Nakamura
 Name: Yuuki NAKAMURA
2010. 4. 19